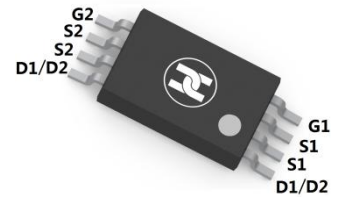
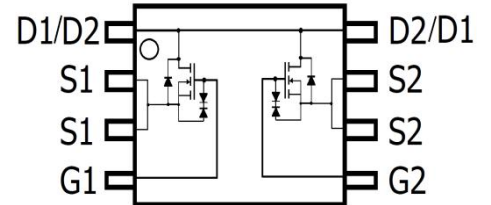


DUAL N-CHANNEL ENHANCEMENT MODE FET

FEATURES

- Ultra low on-resistance: $V_{DS}=20V, I_D=7A, R_{DS(ON)} \leq 22m\Omega @ V_{GS}=4.5V$
- Low gate charge
- ESD protected
- Surface Mount device


TSSOP-8


MECHANICAL DATA

- Case: TSSOP-8
- Case Material: Molded Plastic. UL flammability
- Classification Rating: 94V-0
- Weight: not available

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	20	V
Gate-source voltage	V_{GS}	± 8	V
Continuous drain current	I_D	7	A
		5.7	A
Pulsed drain current	I_{DM}	30	A
Power dissipation	P_D	1.5	W
		1	W
Thermal resistance from Junction to ambient	$R_{\theta JA}$	120	$^\circ\text{C/W}$
Thermal resistance from Junction to Lead	$R_{\theta JL}$	70	$^\circ\text{C/W}$
Junction temperature	T_J	150	$^\circ\text{C}$
Storage temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Drain-Source breakdown voltage	$V_{(BR)DSS}^*$	20			V	$V_{GS}=0V, I_D=250\mu A$
Zero gate voltage drain current	I_{DSS}^*			1	μA	$V_{DS}=16V, V_{GS}=0V$
				5	μA	$V_{DS}=16V, V_{GS}=0V, T_J=55^\circ\text{C}$
Gate-body leakage current	I_{GSS}^*			± 1	μA	$V_{DS}=0V, V_{GS}=\pm 4.5V$
				± 10	μA	$V_{DS}=0V, V_{GS}=\pm 8V$
Gate-threshold voltage	$V_{GS(th)}^*$	0.4	0.6	1	V	$V_{DS}=V_{GS}, I_D=250\mu A$
On-State Drain Current	$I_{D(ON)}^*$	30			A	$V_{DS}=5V, V_{GS}=4.5V$
Drain-source on-resistance	$R_{DS(ON)}^*$		16.5	22	$m\Omega$	$V_{GS}=4.5V, I_D=7A$
			23	29	$m\Omega$	$V_{GS}=4.5V, I_D=7A, T_J=125^\circ\text{C}$
			20	27	$m\Omega$	$V_{GS}=2.5V, I_D=5.5A$
			24	35	$m\Omega$	$V_{GS}=1.8V, I_D=5A$
Forward transconductance	g_{FS}		29		S	$V_{DS}=5V, I_D=7A$
Diode forward voltage	V_{SD}		0.76	1	V	$I_S=1A, V_{GS}=0V$
Diode forward current	I_S			2.5	A	
Input capacitance	C_{iss}		1160		pF	$V_{DS}=10V, V_{GS}=0V, f=1\text{MHz}$
Output capacitance	C_{oss}		187		pF	
Reverse transfer capacitance	C_{rss}		146		pF	
Gate resistance	R_g		1.5		Ω	$V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$
Total gate charge	Q_g		16		nC	$V_{GS}=4.5V, V_{DS}=10V, I_D=7A$
Gate-source charge	Q_{gs}		0.8		nC	
Gate-drain charge	Q_{gd}		3.8		nC	
Turn-on delay time	$t_{d(on)}$		6.2		nS	$V_{GS}=5V, V_{DS}=10V, R_{GEN}=3\Omega, R_L=1.35\Omega$
Turn-on rise time	t_r		12.7		nS	
Turn-off delay time	$t_{d(off)}$		51.7		nS	
Turn-off fall time	t_f		16		nS	
Body Diode Reverse Recovery Time	t_{rr}		17.7		nS	$I_F=7A, dI/dt=100A/\mu s$
Body Diode Reverse Recovery Charge	Q_{rr}		6.7		nC	$I_F=7A, dI/dt=100A/\mu s$

*Pulse test ; Pulse width $\leq 300\mu s$, Duty cycle $\leq 0.5\%$.

DUAL N-CHANNEL ENHANCEMENT MODE FET

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

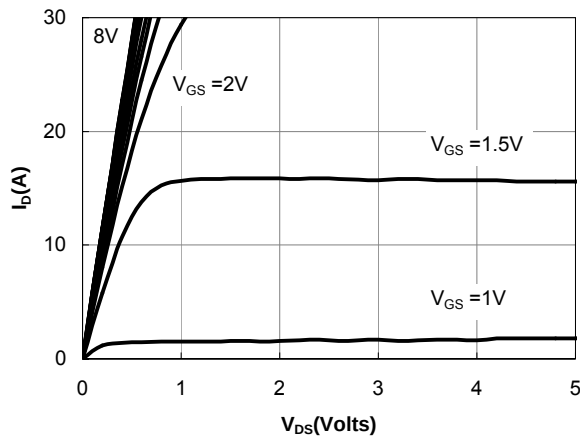


Figure 1: On-Regions Characteristics

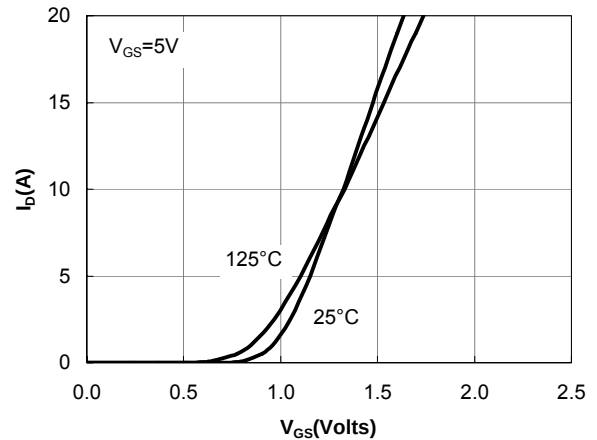


Figure 2: Transfer Characteristics

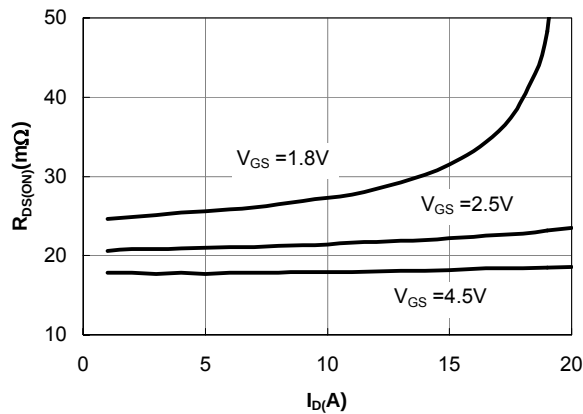


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

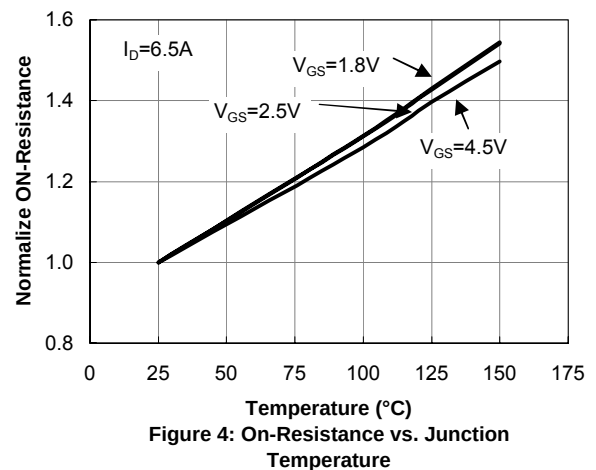


Figure 4: On-Resistance vs. Junction Temperature

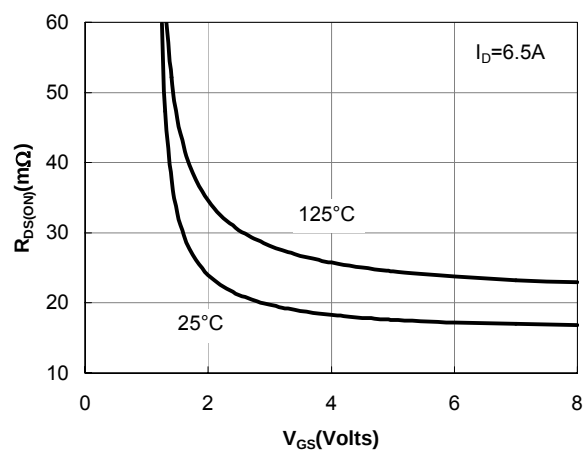


Figure 5: On-Resistance vs. Gate-Source Voltage

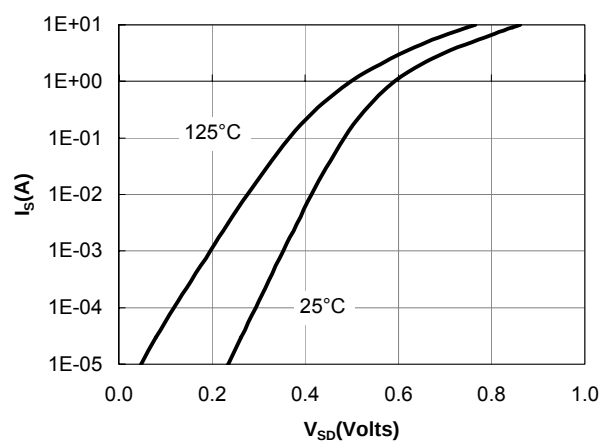


Figure 6: Body-Diode Characteristics

DUAL N-CHANNEL ENHANCEMENT MODE FET

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

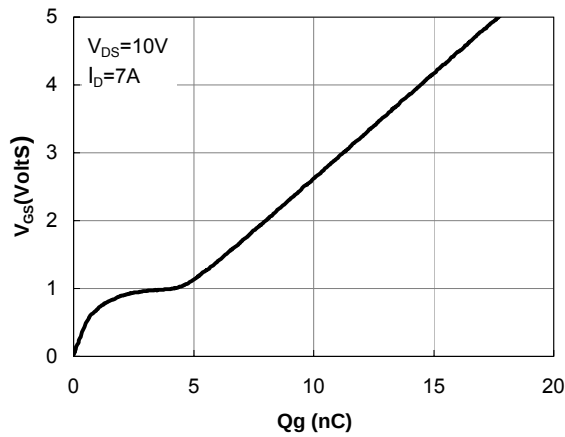


Figure 7: Gate-Charge Characteristics

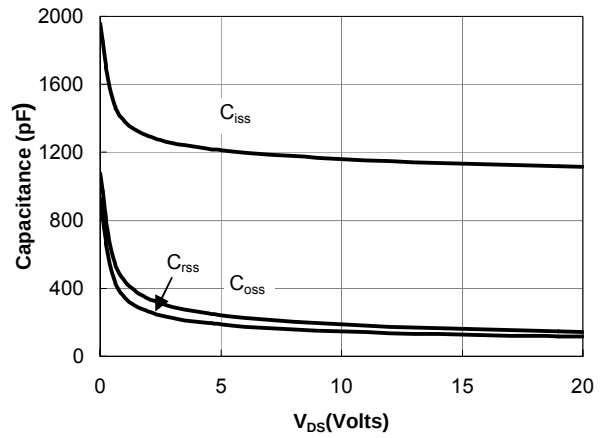


Figure 8: Capacitance Characteristics

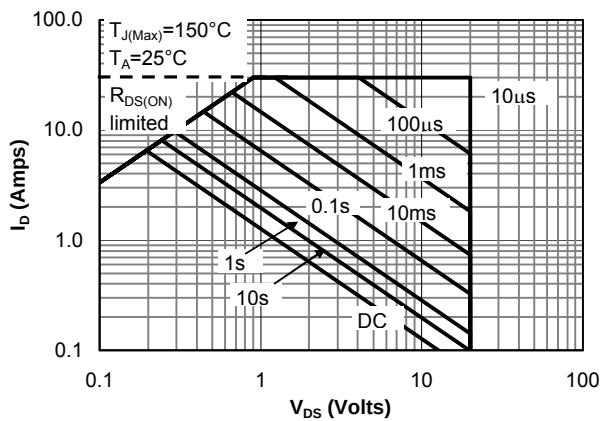


Figure 9: Maximum Forward Biased Safe Operating Area

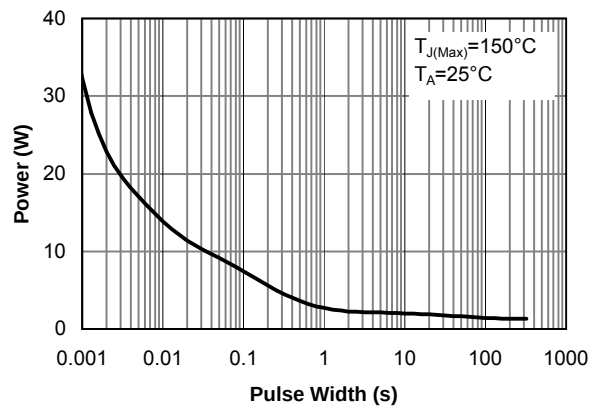


Figure 10: Single Pulse Power Rating Junction-to-Ambient

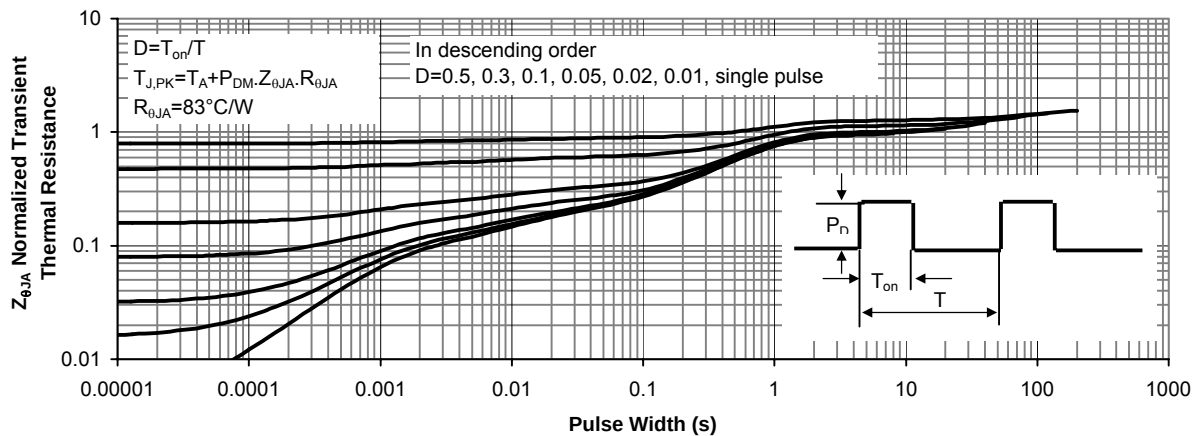
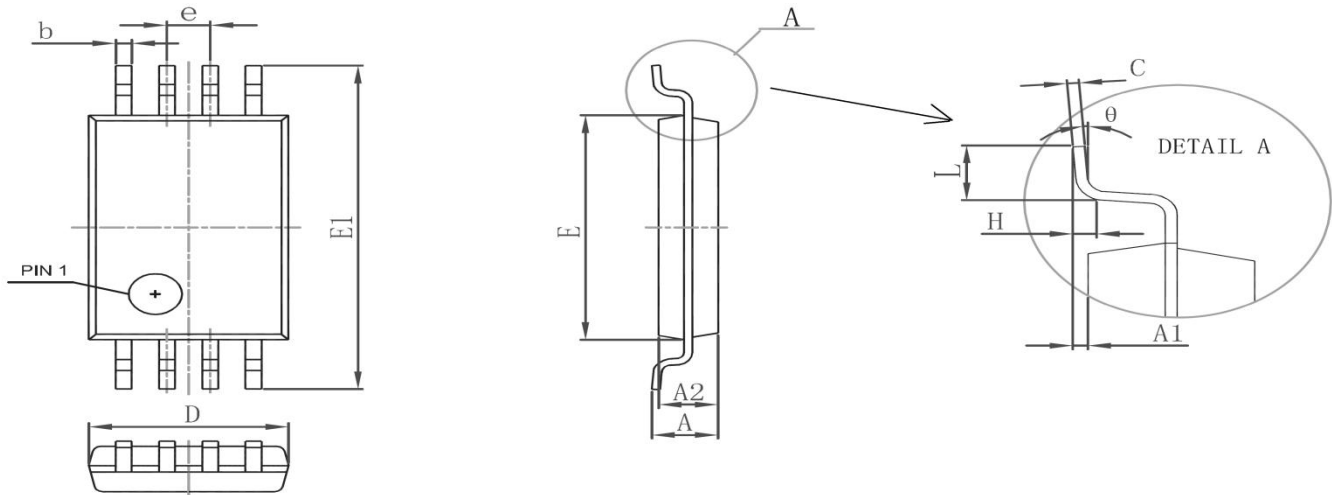


Figure 11: Normalized Maximum Transient Thermal Impedance

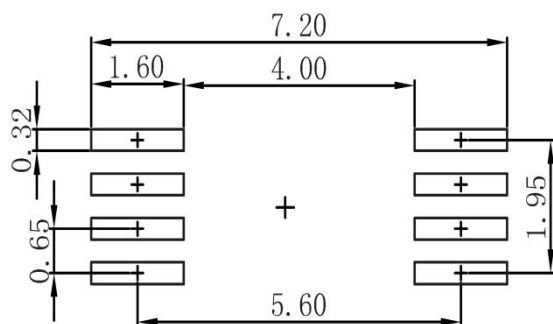
DUAL N-CHANNEL ENHANCEMENT MODE FET

TSSOP-8 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
D	2.900	3.100	0.114	0.122
E	4.300	4.500	0.169	0.177
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
E1	6.250	6.550	0.246	0.258
A		1.200		0.047
A2	0.800	1.000	0.031	0.039
A1	0.050	0.150	0.002	0.006
e	0.65(BSC)		0.026(BSC)	
L	0.500	0.700	0.020	0.028
H	0.25(TYP)		0.01(TYP)	
θ	1°	7°	1°	7°

TSSOP-8 Suggested Pad Layout



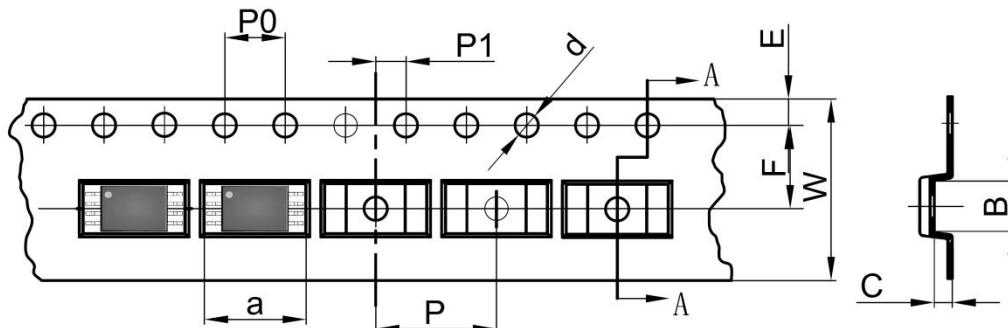
Note:

1. Controlling dimension: in millimeters
2. General tolerance: $\pm 0.05\text{mm}$
3. The pad layout is for reference purposes only

DUAL N-CHANNEL ENHANCEMENT MODE FET

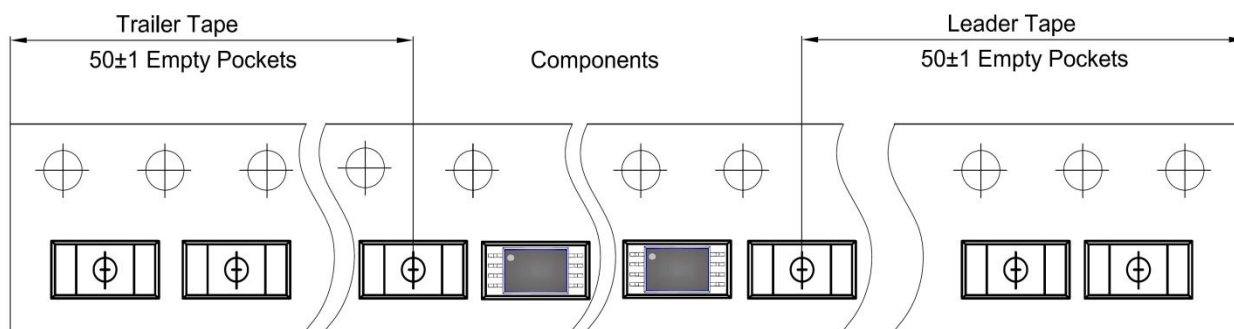
TSSOP-8 Tape and Reel

TSSOP-8 Embossed Carrier Tape

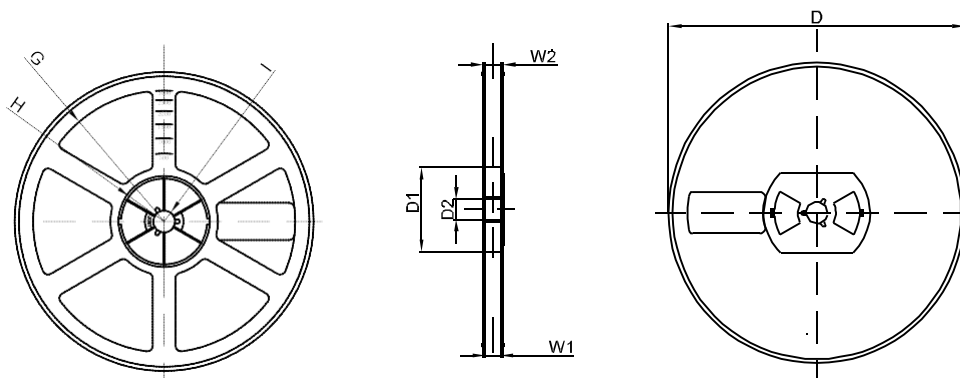


DIMENSIONS ARE IN MILLIMETER										
TYPE	a	B	C	d	E	F	P0	P	P1	W
TSSOP-8	6.76	3.30	1.20	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00
TOLERANCE	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1

TSSOP-8 Tape Leader and Trailer



TSSOP-8 Reel



DIMENSIONS ARE IN MILLIMETER								
REEL OPTION	D	D1	D2	G	H	I	W1	W2
13" DIA	Ø330.00	100.00	13.00	R151.00	R56.00	R6.50	12.40	17.60
TOLERANCE	±2	±1	±1	±1	±1	±1	±1	±1